

## 3 bq27x10EVM Circuit Module Schematic

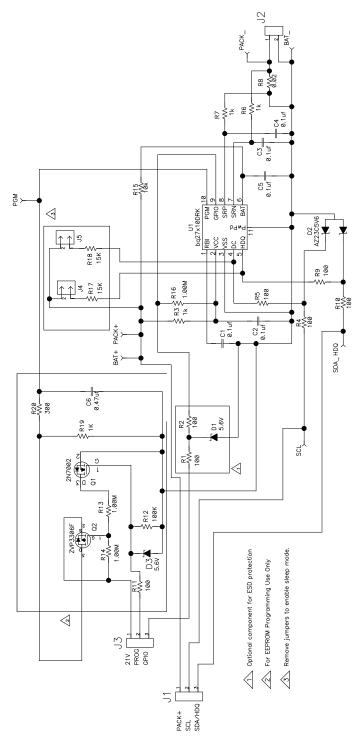


Figure 1. bq27x10EVM Schematic

## 4 bq27x10EVM Circuit Module Physical Layouts

Figure 2 through Figure 7 show the PCB layers and assembly drawing for the bq27x10EVM circuit module.

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